



A Product Line of Diodes Incorporated



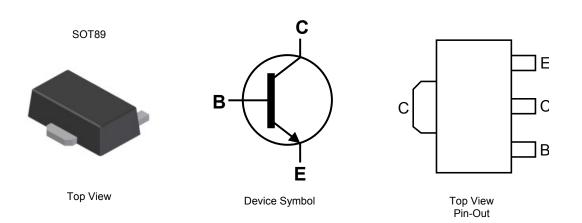
350V NPN HIGH VOLTAGE TRANSISTOR IN SOT89

Features

- BV_{CEO} > 350V
- I_C = 0.5A High Continuous Current
- I_{CM} = 1A Peak Pulse Current
- High H_{FE} Hold Up
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT89
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.072 grams (Approximate)



Ordering Information (Note 4)

Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
BST39TA	AT1	7	12	1,000
BST39-13R	AT1	13	12	4,000

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

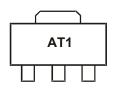
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

Marking Information

Notes:



AT1 = Product Type Marking Code





Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	400	V
Collector-Emitter Voltage	V _{CEO}	350	V
Emitter-Base Voltage	V _{EBO}	7	V
Continuous Collector Current	Ic	500	mA
Peak Pulse Current	I _{CM}	1	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
	(Note 5)		1		
Power Dissipation	(Note 6)	PD	1.5	W	
	(Note 7)		2.0		
	(Note 5)		125	°C/W	
Thermal Resistance, Junction to Ambient Air	(Note 6)	R _{0JA}	83		
	(Note 7)		60		
Thermal Resistance, Junction to Lead	(Note 8)	R _{θJL}	22		
Thermal Resistance, Junction to Case	(Note 9)	R _{θJC}	16		
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

ESD Ratings (Note 10)

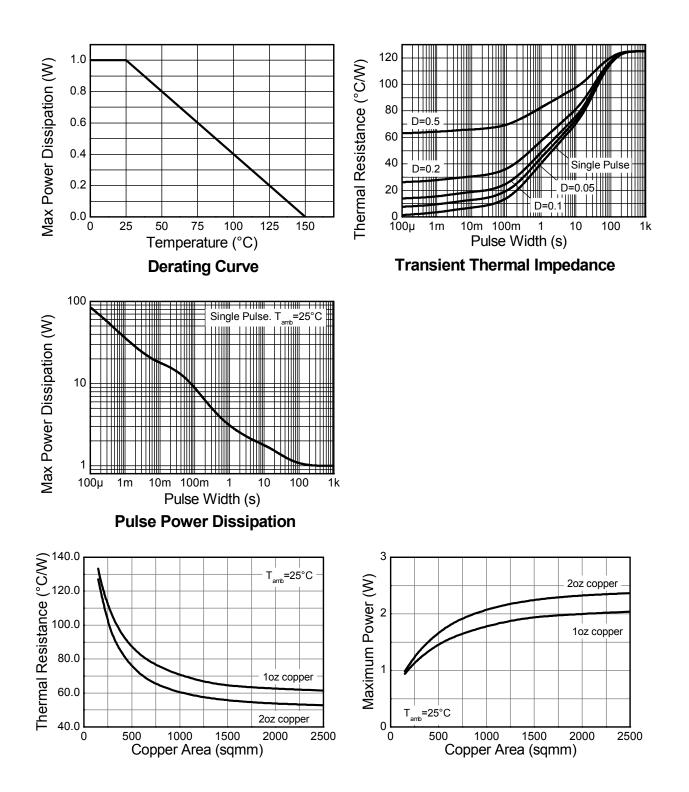
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes: 5. For a device mounted with the exposed collector pad on 15mm x 15mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured For a device mounted with the exposed collector pad on 15mm x 15mm 1oz cop under still air conditions whilst operating in a steady-state.
Same as Note 5, except the device is mounted on 25mm x 25mm 1oz copper.
Thermal resistance from junction to solder-point (on the exposed collector pad).
Thermal resistance from junction to the top of the case.
Refer to JEDEC specification JESD22-A114 and JESD22-A115.





Thermal Characteristics and Derating Information







Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

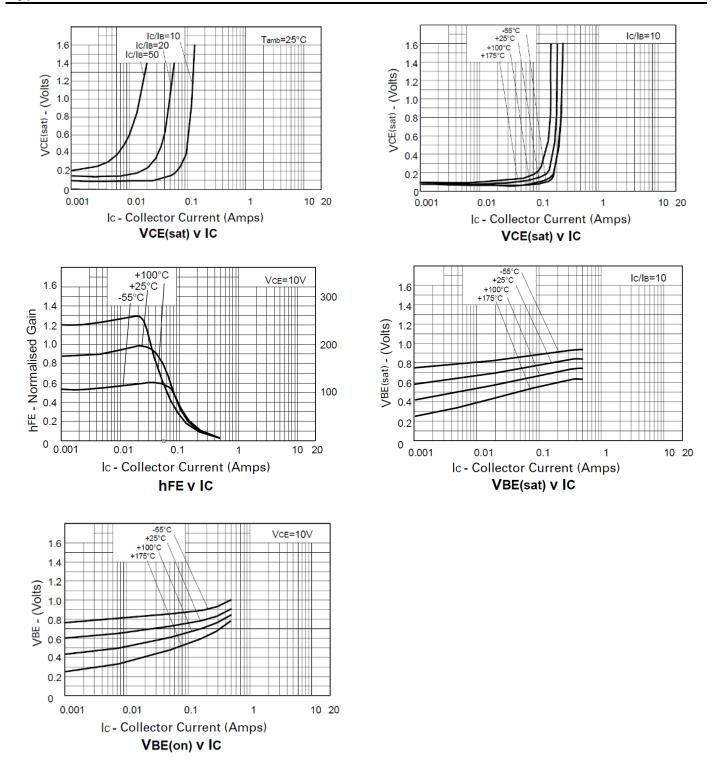
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	400	—	—	V	I _C = 100μA
Collector-Emitter Breakdown Voltage (Notes 11)	BV _{CEO}	350	—	—	V	I _C = 1mA
Emitter-Base Breakdown Voltage	BV _{EBO}	7	—	—	V	I _E = 100μA
Collector Cutoff Current	I _{CBO}	_	—	20	nA	V _{CB} = 300V
DC Current transfer Static Ratio (Notes 11)	h _{FE}	40	—	-	—	I _C = 20mA, V _{CE} = 10V
Collector-Emitter Saturation Voltage (Notes 11)	V _{CE(sat)}	_	—	0.5	V	I _C = 50mA, I _B = 4mA
Base-Emitter Saturation Voltage (Notes 11)	V _{BE(sat)}	-	—	1.3	V	I _C = 50mA, I _B = 4mA
Transitional Frequency (Notes 11)	f _T	70	_	—	MHz	$I_C = 10$ mA, $V_{CE} = 10$ V, f = 5MHz
Output Capacitance	C _{obo}	—	—	2	pF	V _{CB} = 10V, f = 1MHz,
Input Capacitance	C _{ibo}	_	—	20	pF	V _{EB} = 10V, f = 1MHz,

Note: 11. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.





Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

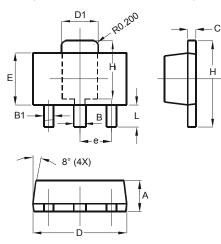






Package Outline Dimensions

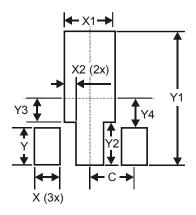
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT89					
Dim	Min	Max			
Α	1.40	1.60			
В	0.44	0.62			
B1	0.35	0.54			
С	0.35	0.44			
D	4.40	4.60			
D1	1.62	1.83			
ш	2.29	2.60			
е	1.50 Typ				
Н	3.94	4.25			
H1	2.63	2.93			
L	0.89	1.20			
All Di	All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.900
X1	1.733
X2	0.416
Y	1.300
Y1	4.600
Y2	1.475
Y3	0.950
Y4	1.125
С	1.500





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